

Data sheet

VIPA CPU 314ST (314-6CF23)

Technical data

Order no.	314-6CF23
Туре	VIPA CPU 314ST
Concretion	
General information	
Note	-
Features	Powered by SPEED7 Work memory [KB]: 5122.048 Onboard 8x DI / 8x DIO / 5x AI [current/voltage] / 2x AO / 1x Pt100 / 4x Counter SPEED-Bus Interface [RJ45]: Ethernet PG/OP communication Interface [2x RS485]: MPI, PROFIBUS master/slave, PtP: ASCII, STX/ETX, 3964 (R), USS master, Modbus master/slave Including front connector SD/MMC card slot with locking, up to 32 modules stackable, programmable with WinPLC7, SIMATIC Manager and TIA Portal
SPEED-Bus	yes
Technical data power supply	
Power supply (rated value)	DC 24 V
Power supply (permitted range)	DC 20.428.8 V
Reverse polarity protection	yes
Current consumption (no-load operation)	300 mA
Current consumption (rated value)	1 A
Inrush current	5 A
²t	0.5 A²s
Max. current drain at backplane bus	2.5 A
Max. current drain load supply	-
Power loss	14 W
Technical data digital inputs	
Number of inputs	8
Cable length, shielded	1000 m
Cable length, unshielded	600 m
Rated load voltage	DC 24 V
Reverse polarity protection of rated load voltage	yes
Current consumption from load voltage L+ (without load)	70 mA
Rated value	DC 24 V
Input voltage for signal "0"	DC 05 V
Input voltage for signal "1"	DC 1528.8 V
Input voltage hysteresis	-
Signal logic input	Sinking input
Frequency range	-
Input resistance	-
Input current for signal "1"	6 mA
Connection of Two-Wire-BEROs possible	yes
Max. permissible BERO quiescent current	1.5 mA
Input delay of "0" to "1"	parameterizable 2.56µs - 40ms



Input delay of "1" to "0"	parameterizable 2.56µs - 40ms
Number of simultaneously utilizable inputs horizontal	8
configuration	
Number of simultaneously utilizable inputs vertical configuration	8
Input characteristic curve	IEC 61131-2, type 1
Initial data size	34 Byte
Technical data digital outputs	
Number of outputs	8
Cable length, shielded	1000 m
Cable length, unshielded	600 m
Rated load voltage	DC 24 V
Reverse polarity protection of rated load voltage	-
Current consumption from load voltage L+ (without load)	30 mA
Total current per group, horizontal configuration, 40°C	4 A
Total current per group, horizontal configuration, 60°C	3 A
Total current per group, vertical configuration	3 A
Output voltage signal "1" at min. current	L+ (-0.8 V)
Output voltage signal "1" at max. current	L+ (-0.8 V)
Output current at signal "1", rated value	0.5 A
Signal logic output	Sourcing output
Output current, permitted range to 40°C	5 mA to 0.6 A
Output current, permitted range to 60°C	5 mA to 0.6 A
Output current at signal "0" max. (residual current)	100 μΑ
Output delay of "0" to "1"	100 μs
Output delay of "1" to "0"	100 µs
Minimum load current	-
Lamp load	5 W
Parallel switching of outputs for redundant control of a load	possible
Parallel switching of outputs for increased power	not possible
Actuation of digital input	yes
Switching frequency with resistive load	max. 2.5 kHz
Switching frequency with inductive load	max. 0.5 Hz
Switching frequency on lamp load	max. 2.5 kHz
Internal limitation of inductive shut-off voltage	L+ (-52 V)
Short-circuit protection of output	yes, electronic
Trigger level	1 A
Number of operating cycle of relay outputs	-
Switching capacity of contacts	-
Output data size	18 Byte
Technical data analog inputs	
Number of inputs	5
Cable length, shielded	200 m
Rated load voltage	DC 24 V
Reverse polarity protection of rated load voltage	yes
Current consumption from load voltage L+ (without load)	85 mA
Voltage inputs	yes
Min. input resistance (voltage range)	120 kOhm

Input voltage ranges	-10 V +10 V 0 V +10 V
Operational limit of voltage ranges	+/-0.3%
Operational limit of voltage ranges with SFU	-
Basic error limit voltage ranges	+/-0.3%
Basic error limit voltage ranges with SFU	-
Destruction limit voltage	max. 15V
Current inputs	yes
Max. input resistance (current range)	85 Ohm
Input current ranges	-20 mA +20 mA 0 mA +20 mA +4 mA +20 mA
Operational limit of current ranges	+/-0.3%
Operational limit of current ranges with SFU	-
Basic error limit current ranges	+/-0.2%
Radical error limit current ranges with SFU	-
Destruction limit current inputs (electrical current)	max. 50mA
Destruction limit current inputs (voltage)	max. 15V
Resistance inputs	yes
Resistance ranges	0 600 Ohm
Operational limit of resistor ranges	+/-0.4%
Operational limit of resistor ranges with SFU	-
Basic error limit	+/-0.2%
Basic error limit with SFU	-
Destruction limit resistance inputs	max. 15V
Resistance thermometer inputs	yes
Resistance thermometer ranges	Pt100 Pt1000 Ni100 Ni1000
Operational limit of resistance thermometer ranges	+/-0.6%
Operational limit of resistance thermometer ranges with SFU	-
Basic error limit thermoresistor ranges	+/-0.4%
Basic error limit thermoresistor ranges with SFU	-
Destruction limit resistance thermometer inputs	max. 15V
Thermocouple inputs	-
Thermocouple ranges	-
Operational limit of thermocouple ranges	-
Operational limit of thermocouple ranges with SFU	-
Basic error limit thermoelement ranges	-
Basic error limit thermoelement ranges with SFU	-
Destruction limit thermocouple inputs	-
Programmable temperature compensation	-
External temperature compensation	-
Internal temperature compensation	-
Technical unit of temperature measurement	°C
Resolution in bit	12
Measurement principle	
Measurement principle	Sigma-Delta
Basic conversion time	Sigma-Delta 6 ms



Technical	data ana	log outputs
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rechnical data analog outputs	
Number of outputs	2
Cable length, shielded	200 m
Rated load voltage	DC 24 V
Reverse polarity protection of rated load voltage	yes
Current consumption from load voltage L+ (without load)	-
Voltage output short-circuit protection	-
Voltage outputs	yes
Min. load resistance (voltage range)	1 kOhm
Max. capacitive load (current range)	1 μF
Max. inductive load (current range)	30 mA
Output voltage ranges	-10 V +10 V 0 V +10 V
Operational limit of voltage ranges	+/-0.4%
Basic error limit voltage ranges with SFU	+/-0.3%
Destruction limit against external applied voltage	max. 15V
Current outputs	yes
Max. in load resistance (current range)	500 Ohm
Max. inductive load (current range)	10 mH
Typ. open circuit voltage current output	16 V
Output current ranges	-20 mA +20 mA 0 mA +20 mA +4 mA +20 mA
Operational limit of current ranges	+/-0.4%
Radical error limit current ranges with SFU	+/-0.3%
Destruction limit against external applied voltage	max. 15V
Settling time for ohmic load	0.2 ms
Settling time for capacitive load	0.5 ms
Settling time for inductive load	0.75 ms
Resolution in bit	12
Conversion time	1 ms
Substitute value can be applied	yes
Output data size	4 Byte
Technical data counters	
Number of counters	4
Counter width	32 Bit
Maximum input frequency	100 kHz
Maximum count frequency	100 kHz
Mode incremental encoder	yes
Mode pulse / direction	yes
Mode pulse	yes
Mode frequency counter	-
Mode period measurement	-
Gate input available	yes
Latch input available	yes
Reset input available	yes
Counter output available	yes

Load memory, integrated	2 MB
Load memory, maximum	2 MB
Work memory, integrated	512 KB
Work memory, maximal	2 MB
Memory divided in 50% program / 50% data	yes
Memory card slot	SD/MMC-Card with max. 2 GB
Hardware configuration	SS/IIIII Gard Will Haxt 2 GB
Racks, max.	4
Modules per rack, max.	8 in multiple-, 32 in a single-rack configuration
Number of integrated DP master	1
Number of DP master via CP	4
Operable function modules	8
Operable communication modules PtP	8
Operable communication modules LAN	8
Status information, alarms, diagnostics	
Status display	Voc
Interrupts	yes yes
Process alarm	yes, parameterizable
Diagnostic interrupt	yes, parameterizable yes, parameterizable
Diagnostic functions	yes Ves
Diagnostics information read-out	possible
Supply voltage display	green LED
Group error display	red SF LED
Channel error display	red LED per group
Isolation	1. 3.41
Between channels	yes
Between channels of groups to	8
Between channels and backplane bus	yes
Between channels and power supply	-
Max. potential difference between circuits	DC 75 V/ AC 50 V
Max. potential difference between inputs (Ucm)	-
Max. potential difference between Mana and Mintern (Uiso)	-
Max. potential difference between inputs and Mana (Ucm)	-
Max. potential difference between inputs and Mintern (Uiso)	-
Max. potential difference between Mintern and outputs	-
Insulation tested with	DC 500 V
Command processing times	
Bit instructions, min.	0.01 μs
Word instruction, min.	0.01 µs
Double integer arithmetic, min.	0.01 µs
Floating-point arithmetic, min.	0.06 μs
Timers/Counters and their retentive characteristi	cs
Number of S7 counters	512
S7 counter remanence	0 512
S7 counter remanence adjustable	C0 C7
Number of S7 times	512
S7 times remanence	0 512

Data range and retentive characteristic		The state of the s
Number of flags 8192 Byte Bit memories retentive characteristic adjustable 0 . 8192 Bit memories retentive characteristic preset MB0 . MB15 Number of data blocks 4095 Max. data blocks size 64 KB Max. local data size per execution level 1024 Byte Blocks	·	not retentive
Bit memories retentive characteristic adjustable 0 8192 Bit memories retentive characteristic preset MED MB15 Number of data blocks 495 Max. data blocks size 64 KB	Data range and retentive characteristic	
Bit memories retentive characteristic preset	Number of flags	8192 Byte
Number of data blocks 4095 Max. Ideal blocks size 64 KB Max. Ideal data size per execution level 1024 Byte Blocks 1024 Byte Blocks 23 Number of FBs 2048 Number of FCs 2048 Maximum nesting depth per priority class 8 Maximum nesting depth additional within an error OB 4 Time Ves Real-time clock buffered yes Colock buffered period (min.) 6 w Accuracy (max. deviation per day) 10 s Number of operating hours counter 8 Clock synchronization via MPI Mester/Slave Synchronization via Ethernet (NTP) no Address areas (I/O) 8 Input I/O address area 8192 Byte Output I/O address area 8192 Byte Input process image maximal 2048 Byte Output I/O address area 8192 Byte Injust process image maximal 2048 Byte Output I/O address area 8192 Byte Oightal inputs central 1032	Bit memories retentive characteristic adjustable	0 8192
Max. data blocks size 64 KB Max. local data size per execution level 1024 Byte Blocks	Bit memories retentive characteristic preset	MB0 MB15
Max. local data size per execution level 1024 Byte	Number of data blocks	4095
Number of OBs	Max. data blocks size	64 KB
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Output I/O address area Input process image maximal Output process image m	Address areas (I/O)	
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Digital inputs central 1032 Digital outputs central 1032 Integrated digital inputs 8 Integrated digital outputs 8 Analog inputs 1024 Analog outputs 1024 Analog outputs 261 Analog outputs, central 261 Analog outputs, central 258 Integrated analog inputs 5 Integrated analog outputs 22 Communication functions PG/OP channel yes Global data communication yes Number of GD circuits, max. 4 Size of GD packets, max. 22 Byte S7 basic communication yes	Digital inputs	65536
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Integrated digital inputs 8 Integrated digital outputs 8 Analog inputs 1024 Analog outputs 1024 Analog outputs, central 261 Analog outputs, central 258 Integrated analog inputs 5 Integrated analog outputs 2 Communication functions PG/OP channel yes Global data communication yes Number of GD circuits, max. 4 Size of GD packets, max. 22 Byte S7 basic communication yes	Digital inputs central	1032
Integrated digital outputs 8 Analog inputs 1024 Analog outputs 1024 Analog inputs, central 261 Analog outputs, central 258 Integrated analog inputs 5 Integrated analog outputs 2 Communication functions PG/OP channel yes Global data communication yes Number of GD circuits, max. 4 Size of GD packets, max. 22 Byte S7 basic communication yes	Digital outputs central	1032
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Integrated analog inputs 5 Integrated analog outputs 2 Communication functions PG/OP channel yes Global data communication yes Number of GD circuits, max. 4 Size of GD packets, max. 22 Byte S7 basic communication yes	Analog inputs, central	261
Integrated analog outputs 2 Communication functions PG/OP channel yes Global data communication yes Number of GD circuits, max. 4 Size of GD packets, max. 22 Byte S7 basic communication yes	Analog outputs, central	258
Communication functions PG/OP channel yes Global data communication yes Number of GD circuits, max. 4 Size of GD packets, max. 22 Byte S7 basic communication yes	Integrated analog inputs	5
PG/OP channel yes Global data communication yes Number of GD circuits, max. 4 Size of GD packets, max. 22 Byte S7 basic communication yes	Integrated analog outputs	2
Global data communication yes Number of GD circuits, max. 4 Size of GD packets, max. 22 Byte S7 basic communication yes	Communication functions	
Number of GD circuits, max. 4 Size of GD packets, max. 22 Byte S7 basic communication yes	PG/OP channel	yes
Size of GD packets, max. 22 Byte S7 basic communication yes	Global data communication	yes
S7 basic communication yes	Number of GD circuits, max.	4
·	Size of GD packets, max.	22 Byte
S7 basic communication, user data per job 76 Byte	S7 basic communication	yes
	S7 basic communication, user data per job	76 Byte

S7 communication	yes	
S7 communication as server	yes	
S7 communication as client	-	
S7 communication, user data per job	160 Byte	
Number of connections, max.	32	
PWM data		
PWM channels	-	
PWM time basis	-	
Period length	-	
Minimum pulse width	-	
Type of output	-	
Functionality Sub-D interfaces		
Туре	X2	
Type of interface	RS485	
Connector	Sub-D, 9-pin, female	
Electrically isolated	yes	
MPI	yes	
MP²l (MPl/RS232)	-	
DP master	-	
DP slave	-	
Point-to-point interface	-	
5V DC Power supply	max. 90mA, isolated	
24V DC Power supply	max. 100mA, non-isolated	
Туре	X3	
Type of interface	RS485	
Connector	Sub-D, 9-pin, female	
Electrically isolated	yes	
MPI	-	
MP²l (MPl/RS232)	-	
DP master	yes	
DP slave	yes	
Point-to-point interface	yes	
5V DC Power supply	max. 90mA, isolated	
24V DC Power supply	max. 100mA, non-isolated	
Functionality MPI		
Number of connections, max.	32	
PG/OP channel	yes	
Routing	yes	
Global data communication	yes	
S7 basic communication	yes	
S7 communication	yes	
S7 communication as server	yes	
S7 communication as client	-	
Transmission speed, min.	19.2 kbit/s	
	12 Mbit/s	

Number of connections, max.	32
PG/OP channel	yes
Routing	yes
S7 basic communication	yes
S7 communication	yes
S7 communication as server	yes
S7 communication as client	-
Activation/deactivation of DP slaves	yes
Direct data exchange (slave-to-slave communication)	-
DPV1	yes
Transmission speed, min.	9.6 kbit/s
Transmission speed, max.	12 Mbit/s
Number of DP slaves, max.	124
Address range inputs, max.	1 KB
Address range outputs, max.	1 KB
User data inputs per slave, max.	244 Byte
User data outputs per slave, max.	244 Byte
Oser data outputs per siave, max.	244 Dyle
Functionality PROFIBUS slave	
Number of connections, max.	32
PG/OP channel	yes
Routing	yes
S7 communication	yes
S7 communication as server	yes
S7 communication as client	-
Direct data exchange (slave-to-slave communication)	-
DPV1	yes
Transmission speed, min.	9.6 kbit/s
Transmission speed, max.	12 Mbit/s
Automatic detection of transmission speed	-
Transfer memory inputs, max.	244 Byte
Transfer memory outputs, max.	244 Byte
Address areas, max.	32
User data per address area, max.	32 Byte
Functionality RJ45 interfaces	
Туре	X5
Type of interface	Ethernet 10/100 MBit
Connector	RJ45
Electrically isolated	yes
PG/OP channel	yes
Number of connections, max.	4
Productive connections	-
Point-to-point communication	
PtP communication	yes
Interface isolated	yes
RS232 interface	-
RS422 interface	-
RS485 interface	yes
INOTOU IIIIEIIAUE	you

Connector	Sub-D, 9-pin, female
Transmission speed, min.	150 bit/s
Transmission speed, max.	115.5 kbit/s
Cable length, max.	500 m
Point-to-point protocol	
ASCII protocol	yes
STX/ETX protocol	yes
3964(R) protocol	yes
RK512 protocol	-
USS master protocol	yes
Modbus master protocol	yes
Modbus slave protocol	-
Special protocols	-
Housing	
Material	PPE
Mounting	Rail System 300
Mechanical data	
Dimensions (WxHxD)	80 mm x 125 mm x 120 mm
Net weight	480 g
Weight including accessories	-
Gross weight	-
Environmental conditions	
Operating temperature	0 °C to 60 °C
Storage temperature	-25 °C to 70 °C
Certifications	
UL certification	yes
KC certification	yes